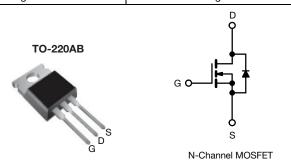
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	60	60				
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	0.10				
Q _g max. (nC)	25	25				
Q _{gs} (nC)	5.8	5.8				
Q _{gd} (nC)	11	11				
Configuration	Sing	Single				



FEATURES

- Dynamic dV/dt rating
- 175 °C operating temperature



- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ24PbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	60		
Gate-Source Voltage			V_{GS}	± 20	V	
Continuous Duais Current	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		17	А	
Continuous Drain Current		T _C = 100 °C	I _D	12		
Pulsed Drain Current ^a			I _{DM}	68		
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P _D	60	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175		
Soldering Recommendations (Peak temperature) d for 10 s			-	300	°C	
Manuatina Taurus	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 403 μ H, R_a = 25 Ω , I_{AS} = 17 A (see fig. 12).
- c. $I_{SD} \leq$ 17 A, $dI/dt \leq$ 140 A/µs, $V_{DD} \leq$ V_{DS} , $T_{J} \leq$ 175 °C.
- d. 1.6 mm from case.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				L	L	L	1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.061	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150 ^{\circ}\text{C}$		-	-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	-	0.10	Ω
Forward Transconductance	9 _{fs}		= 25 V, I _D = 10 A	5.5	-	-	S
Dynamic		_			I.	I.	
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	640	-	pF
Output Capacitance	C _{oss}		$V_{\rm DS} = 0 \text{ V},$ $V_{\rm DS} = 25 \text{ V},$		360	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	79	-	
Total Gate Charge	Q_g			-	-	25	
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V	I _D = 17 A, V _{DS} = 48 V, see fig. 6 and 13 ^b	-	-	5.8	nC
Gate-Drain Charge	Q_{gd}		3	-	-	11	
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	t _r	V _{DD} :	= 30 V, I _D = 17 A,	-	58	-	
Turn-Off Delay Time	t _{d(off)}	$R_{\rm g} = 18 \ \Omega, \ R_{\rm D} = 1.7 \ \Omega, \ {\rm see \ fig. \ 10^{\ b}}$		-	25	-	ns
Fall Time	t _f			-	1		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact - 4.5 - 7.5		-	4.5	-	-11
Internal Source Inductance	L _S			-	nH		
Drain-Source Body Diode Characteristic	s			,	ı	ı	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	17	- A
Pulsed Diode Forward Current ^a	I _{SM}	integral revers	integral reverse p - n junction diode		_	68	
Body Diode Voltage	V _{SD}	T _J = 25 °C	$I_{S} = 17 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	17 A dI/d+ 100 A / -	-	88	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}	T IJ = 25 °C, I	$_{F} = 17 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s}$	-	0.29	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

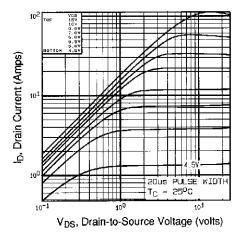


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

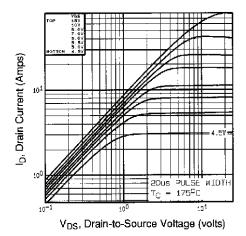


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

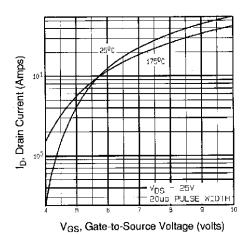


Fig. 3 - Typical Transfer Characteristics

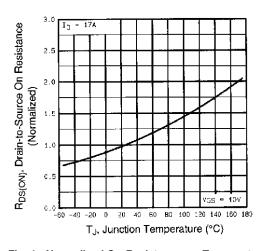


Fig. 4 - Normalized On-Resistance vs. Temperature

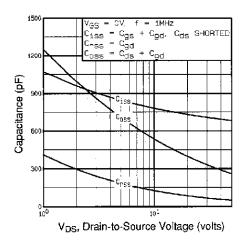


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

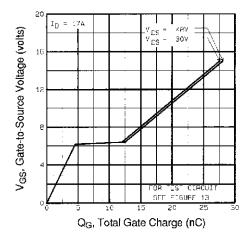


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



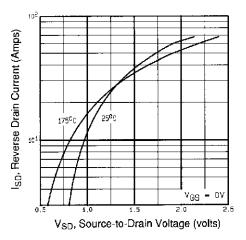


Fig. 7 - Typical Source-Drain Diode Forward Voltage

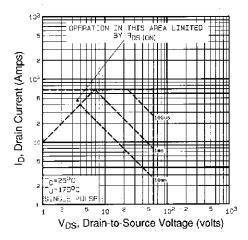


Fig. 8 - Maximum Safe Operating Area

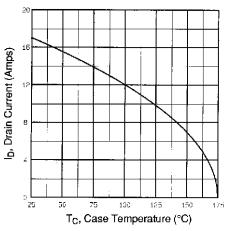


Fig. 9 - Maximum Drain Current vs. Case Temperature

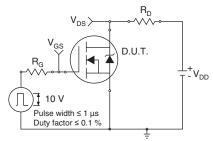


Fig. 10a - Switching Time Test Circuit

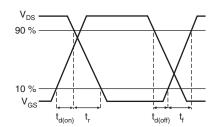


Fig. 10b - Switching Time Waveforms

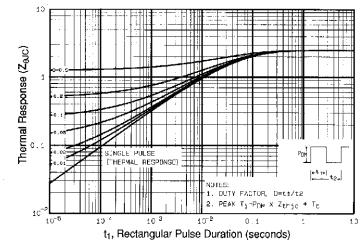


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



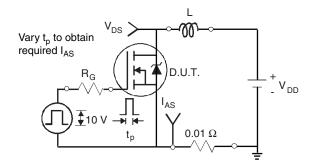


Fig. 12a - Unclamped Inductive Test Circuit

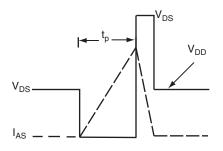


Fig. 12b - Unclamped Inductive Waveforms

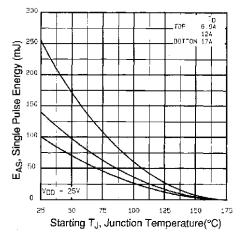


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

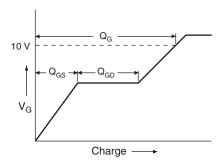


Fig. 13a - Basic Gate Charge Waveform

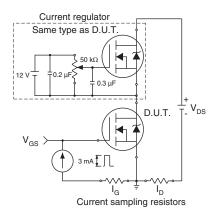
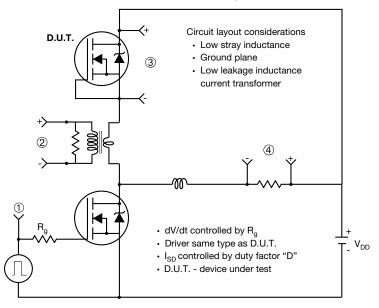


Fig. 13b - Gate Charge Test



Peak Diode Recovery dV/dt Test Circuit



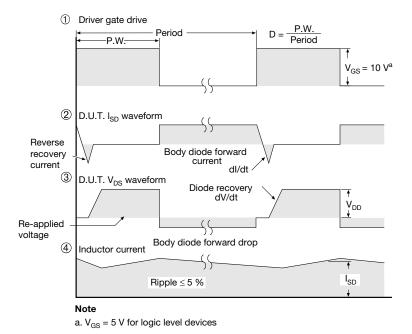


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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Vishay

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